

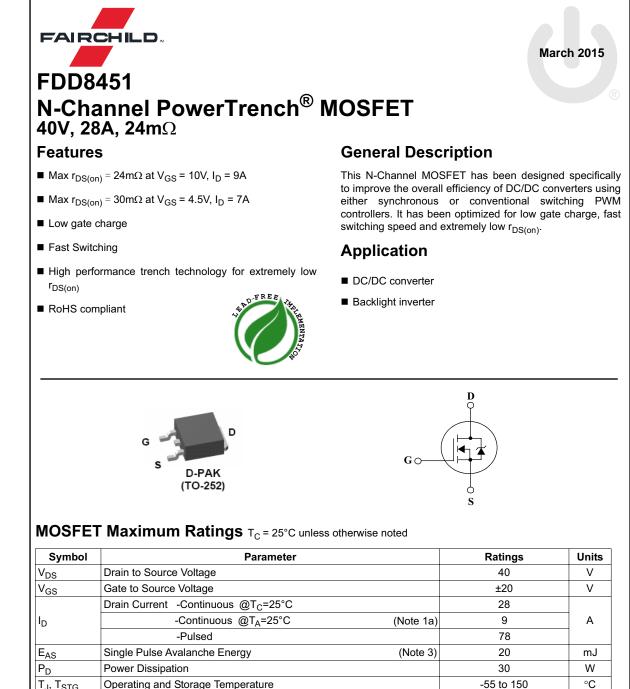
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Device Marking

FDD8451

Thermal Characteristics

Thermal Resistance, Junction to Case

Thermal Resistance, Junction to Ambient

Thermal Resistance, Junction to Ambient

Package Marking and Ordering Information

Device

FDD8451

T_J, T_{STG}

 $R_{\theta JC}$

 $R_{\theta,IA}$

 $R_{\theta JA}$

Package

D-PAK(TO-252)

Quantity

2500 units

°C

°C/W

°C/W

°C/W

4.1 40

96

Tape Width

16mm

(Note 1a)

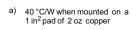
(Note 1b)

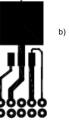
Reel Size

13"

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		33.5		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32V, V _{GS} = 0V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
On Chara	icteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	1	2.1	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu$ A, referenced to 25° C		-5.7		mV/°C
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V, I _D = 9A		19	24	mΩ
		V _{GS} = 4.5V, I _D = 7A		23	30	
		V _{GS} = 10V, I _D = 9A T _J = 150°C		32	41	
9 _{FS}	Forward Transcondductance	V _{DS} = 5V, I _D = 9A		29		S
Dynamic C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$		780 112	990 150	pF pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		72	110	pF
R _g	Gate Resistance	f = 1MHz		1.1		Ω
Oitakin.	g Characteristics					
	-			7	14	ns
t _{d(on)}	Turn-On Delay Time	V _{DD} = 20V, I _D = 9A		7	14 10	ns ns
t _{d(on)} t _r	Turn-On Delay Time Rise Time	V_{DD} = 20V, I _D = 9A V_{GS} = 10V, R _{GEN} = 6 Ω		7 3 19	14 10 34	ns ns ns
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time			3	10	ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time			3 19	10 34	ns ns
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time			3 19 2	10 34 10	ns ns ns
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \\ Q_{g} \end{array}$	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V	V _{GS} = 10V, R _{GEN} = 6Ω		3 19 2 16	10 34 10 20	ns ns ns nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Total Gate Charge at 5V	$V_{GS} = 10V, R_{GEN} = 6\Omega$		3 19 2 16 8.6	10 34 10 20	ns ns ns nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Total Gate Charge at 5V Gate to Source Gate Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$		3 19 2 16 8.6 2.5	10 34 10 20	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd} Drain-So	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate Charge at 10VTotal Gate Charge at 5VGate to Source Gate ChargeGate to Drain "Miller"Charge	$V_{GS} = 10V, R_{GEN} = 6Ω$ $V_{DS} = 20V, I_D = 9A$ $V_{GS} = 10V$ e $V_{GS} = 0V, I_S = 9A$		3 19 2 16 8.6 2.5	10 34 10 20	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Total Gate Charge at 5V Gate to Source Gate Charge Gate to Drain "Miller"Charge urce Diode Characteristics	V_{GS}^{-} = 10V, R_{GEN} = 6Ω V_{DS} = 20V, I_{D} = 9A V_{GS} = 10V		3 19 2 16 8.6 2.5 3.7	10 34 10 20 11	ns ns nC nC nC nC

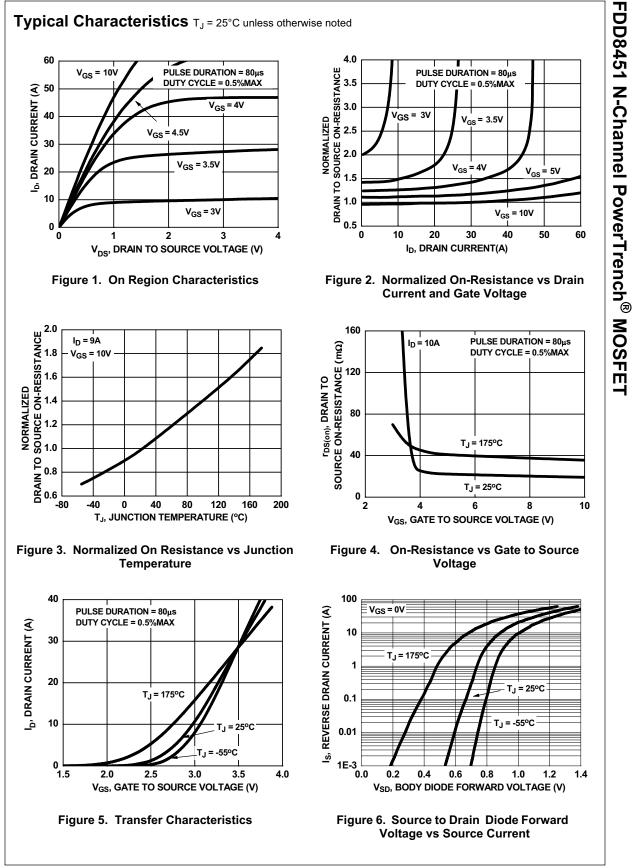




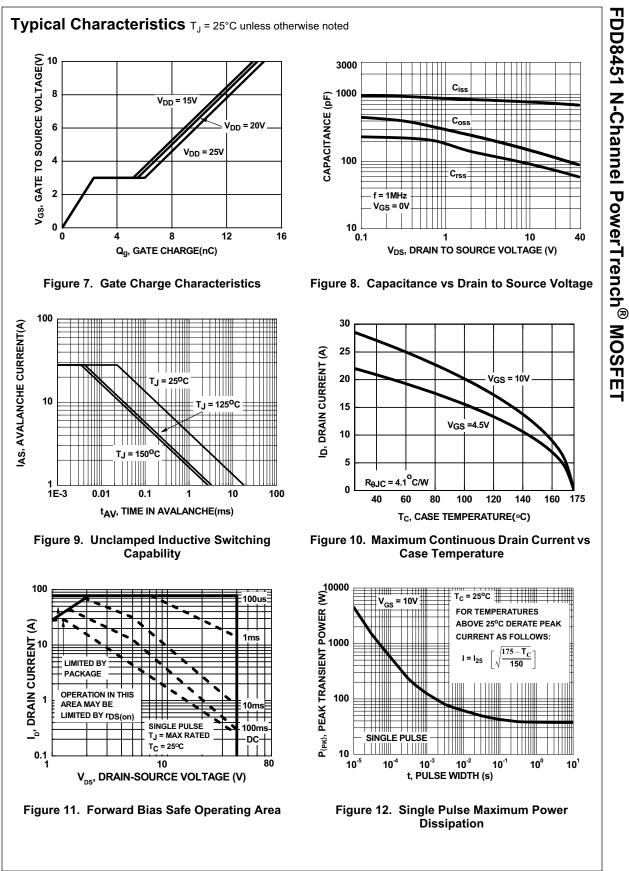


96 °C/W when mounted on a minimum pad

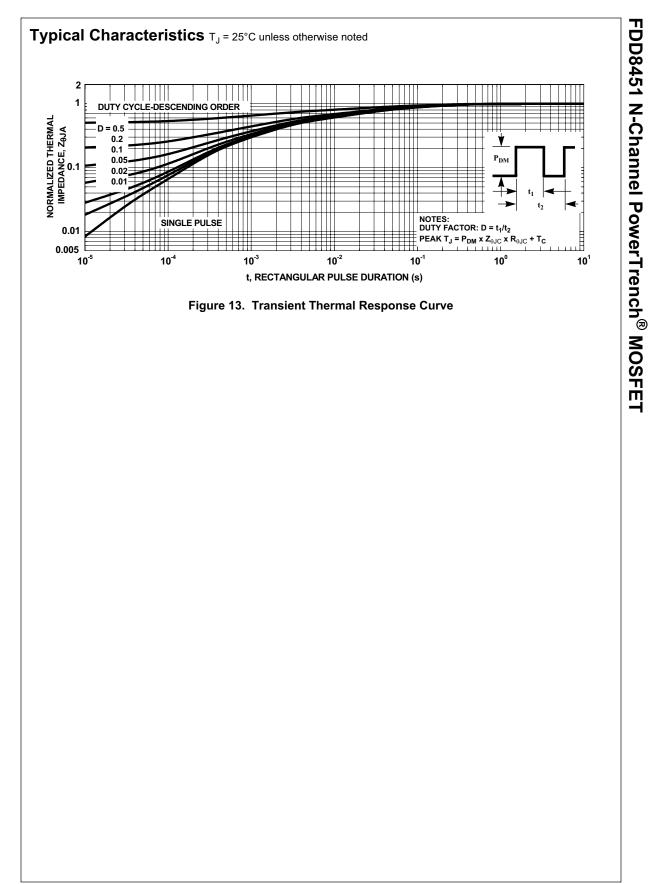
FDD8451 N-Channel PowerTrench[®] MOSFET



FDD8451 Rev. 1.2



FDD8451 Rev. 1.2







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